# 2SC3738

### Silicon NPN triple diffusion planar type

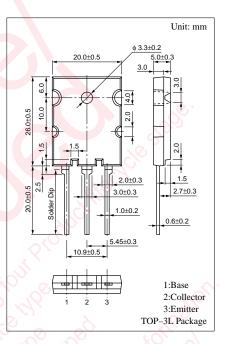
For high breakdown voltage high-speed switching For horizontal deflection output

#### Features

- High-speed switching
- Wide area of safe operation (ASO) with high breakdown voltage
- Satisfactory linearity of foward current transfer ratio  $h_{FE}$

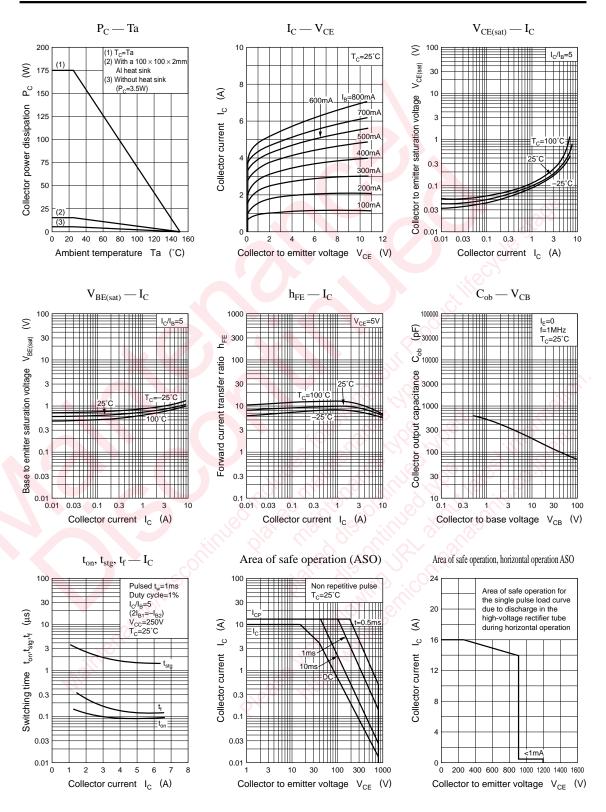
$\sim$ Absolute Maximum Ratings (1 <sub>C</sub> =25 C)							
Parameter	Symbol	Ratings	Unit				
Collector to base voltage	V <sub>CBO</sub>	1200	V				
Collector to emitter voltage	V <sub>CEO</sub>	800	V				
Emitter to base voltage	V <sub>EBO</sub>	7	V				
Peak collector current	I <sub>CP</sub>	<sub>IP</sub> 15					
Collector current	I <sub>C</sub>	10	Α				
Base current	I <sub>B</sub>	5	A				
Collector power T <sub>C</sub> =25°C	D	175	W				
dissipation Ta=25°C	P <sub>C</sub>	3.5	W				
Junction temperature	Tj	150	°C				
Storage temperature	T <sub>stg</sub>	-55 to +150	°C (€				

#### Absolute Maximum Ratings (T<sub>c</sub>=25°C)

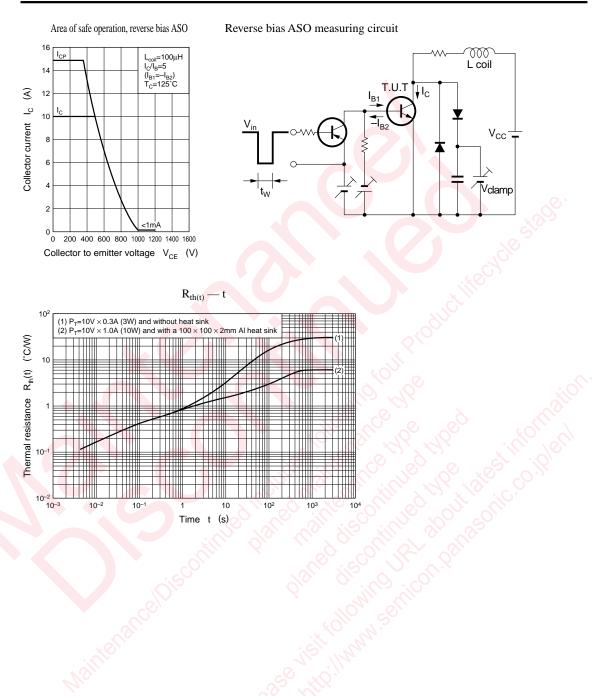


#### Electrical Characteristics $(T_c=25^{\circ}C)$

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I <sub>CBO</sub>	$V_{CB} = 1000V, I_E = 0$	× 3		100	μΑ
Emitter cutoff current	I <sub>EBO</sub>	$V_{\rm EB} = 6V, I_{\rm C} = 0$	Y.		100	μΑ
Collector to emitter voltage	V <sub>CEO</sub>	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 0$	800			V
Forward current transfer ratio	h <sub>FE</sub>	$V_{CE} = 5V, I_C = 4A$	6		20	
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = 4A, I_{\rm B} = 0.8A$			1.5	V
Base to emitter saturation voltage	V <sub>BE(sat)</sub>	$I_{\rm C} = 4A, I_{\rm B} = 0.8A$			2.0	V
Transition frequency	f <sub>T</sub>	$V_{CE} = 5V, I_C = 0.5A, f = 1MHz$		10		MHz
Turn-on time	t <sub>on</sub>				1.0	μs
Storage time	t <sub>stg</sub>	$I_{C} = 4A, I_{B1} = 0.8A, I_{B2} = -1.6A,$ $V_{CC} = 250V$			3.5	μs
Fall time	t <sub>f</sub>				0.3	μs



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